Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1. (Currently Amended) A semiconductor laser, comprising:

at least one absorbing layer (8)-within the laser resonator, said absorbing layer configured to reduce reducing the transmission T_{Res} of the laser radiation (10)-in the laser resonator and decrease for the purpose of decreasing the sensitivity of the semiconductor laser to disturbances created by the radiation (9) fed back into the laser resonator.

- 2. (Currently Amended) The semiconductor laser as claimed in claim 1, in which wherein the absorbing layer (8) is situated in a node of a standing wave that forms during operation of the semiconductor laser in the laser resonator.
- 3. (Currently Amended) The semiconductor laser as claimed in claim 1, in which wherein the reflectivity of the mirrors of the resonator and the transmission T_{Res} of the laser radiation during a resonator circulation are set so as to produce a low sensitivity to disturbances for a wide range of possible output powers of the semiconductor laser.
- 4. (Currently amended) The semiconductor laser as claimed in claim 1-in which wherein the semiconductor laser is a single-mode laser.
 - 5. (Currently Amended) The semiconductor laser as claimed in claim 1, in-which

wherein the semiconductor laser is a surface emitting semiconductor laser (VCSEL).

- 6. (Currently Amended) The semiconductor laser as claimed in claim 1, in which wherein the semiconductor laser is a surface emitting semiconductor laser with an external resonator (VECSEL).
- 7. (Currently Amended) The semiconductor laser as claimed in claim 6, in which wherein the surface emitting semiconductor laser contains comprises a Bragg mirror (4) and the absorbing layer (8) is contained disposed in said Bragg mirror (4).
- 8. (Currently Amended) The semiconductor laser as claimed in claim 1, in which wherein the absorbing layer (8) is a gallium arsenide layer.
- 9. (Currently Amended) The semiconductor laser as claimed in claim 1, in which wherein the gallium arsenide layer is approximately 20 nm thick.
- 10. (Currently amended) The semiconductor laser as claimed in claim 1, which contains further comprising a plurality of absorbing layers within the laser resonator.
- 11. (Currently Amended) The semiconductor laser as claimed in claim 5, in which wherein the surface emitting semiconductor laser contains comprises a Bragg mirror (4) and the absorbing layer (8) is contained in said Bragg mirror (4).